

RBA200N15YANS-3UA03

REXFET-1 N-Channel Power MOSFET

150 V - 200 A - 3.4 m Ω - TOLL for Automotive

Description

The RBA200N15YANS-3UA03 N-channel power MOSFET features REXFET-1 split-gate technology and is offered in a TOLL package. The TOLL package features top-side cooling for ultra-compact and optimal thermal performance. Renesas' REXFET-1 split gate technology is suitable for applications requiring low RDS(on) and switching capability for high-power and high-frequency applications.

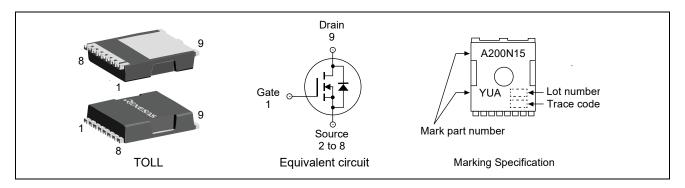
Features

- Standard level gate drive voltage: V_{GS(th)} = 2.2 to 3.7 V
- Super low on-state resistance: $R_{DS(on)} = 3.4 \text{ m}\Omega$ MAX.
- Low input capacitance
- Low thermal resistance
- 100% Avalanche tested
- AEC-Q101 qualified
- PPAP capable
- · Pb-free lead plating: RoHS compliant
- MSL1 classified according to IPC/JEDEC J-STD-020

Application

Small Traction (2-wheel, 3-wheel vehicle), 72 to 96 V load, Onboard charger, Charging station, Low voltage DC/DC,

Outline



Absolute Maximum Ratings

(T_i = 25 °C unless otherwise notice)

Item	Symbol	Ratings	Unit
Drain to Source Voltage	V _{DSS}	150	V
Gate to Source Voltage	V _{GSS}	±20	V
Continuous Drain Current	I _{D(Tc = 25°C)} Note 2,6	±200	А
	I _{D(Tc = 100°C)} Note 2,6	±148	Α
Pulsed Drain Current	I _{D(pulse)} Note 1,2,3,6	±800	Α
Power Dissipation	P _D Note 1,6	366	W
Operating and Storage Temperature	T_{j} , T_{stg}	-55 to 175	°C
Single Avalanche Current	IAS Note 4	75	Α
Single Avalanche Energy	Eas Note 4	421	mJ

Thermal Resistance

Item	Symbol	Min	Тур	Max	Unit
Junction to Case Thermal Resistance	Rth(j-c) Note 6	_	_	0.41	°C/W
Junction to Ambient Thermal Resistance	R _{th(j-a)} Note 5,6	_	_	40	°C/W

Electrical Characteristics

 $(T_j = 25 \text{ °C unless otherwise notice})$

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 150 V, V _{GS} = 0 V
Gate Leakage Current	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.2	_	3.7	V	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$
Drain to Source On-state Resistance	R _{DS(on)}	_	2.8	3.4	mΩ	V _{GS} = 10 V, I _D = 100 A
Input Capacitance	C _{iss}	_	6200	_	pF	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$
Output Capacitance	Coss	_	2100	_	pF	f = 100 kHz
Reverse Transfer Capacitance	C _{rss}	_	37	_	pF	
Gate resistance	Rg	_	4.4	_	Ω	_
Turn-on Delay Time	t _{d(on)}	_	30	_	ns	V _{DD} = 75 V, I _D = 50 A
Rise Time	t _r	_	20	_	ns	$V_{GS} = 10 \text{ V}$ $R_G = 5 \Omega$
Turn-off Delay Time	t _{d(off)}	_	95	_	ns	
Fall Time	t _f	_	20	_	ns	
Total Gate Charge	Qg	_	86	_	nC	$V_{DD} = 75 \text{ V}, I_D = 50 \text{ A}$
Gate to Source Charge	Qgs	_	30	_	nC	V_{GS} = 10 V
Gate to Drain Charge	Q_{gd}	_	15	_	nC	
Gate plateau voltage	V _{plateau}	_	5.0	_	V	
Output Charge	Q _{oss}	_	255	_	nC	V _{DS} = 75 V, V _{GS} = 0 V
Body Diode Forward Voltage	$V_{F(S-D)}$	_	0.87	1.5	V	I _F = 100 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}	_	120	_	ns	I _F = 50 A, V _{GS} = 0 V
Reverse Recovery Charge	Q _{rr}	_	400	_	nC	$d_i/d_t = 100 \text{ A}/\mu \text{s}$

Note 1. $T_c = 25$ °C

^{2.} Value is limited by overall system design including PCB.

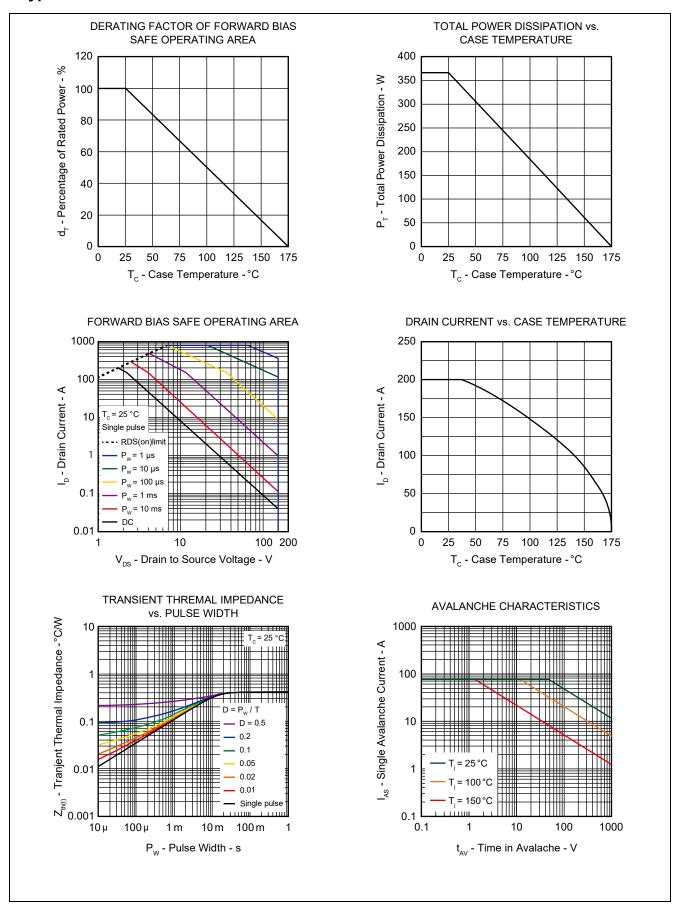
^{3.} PW ≤ 10 *μ*s

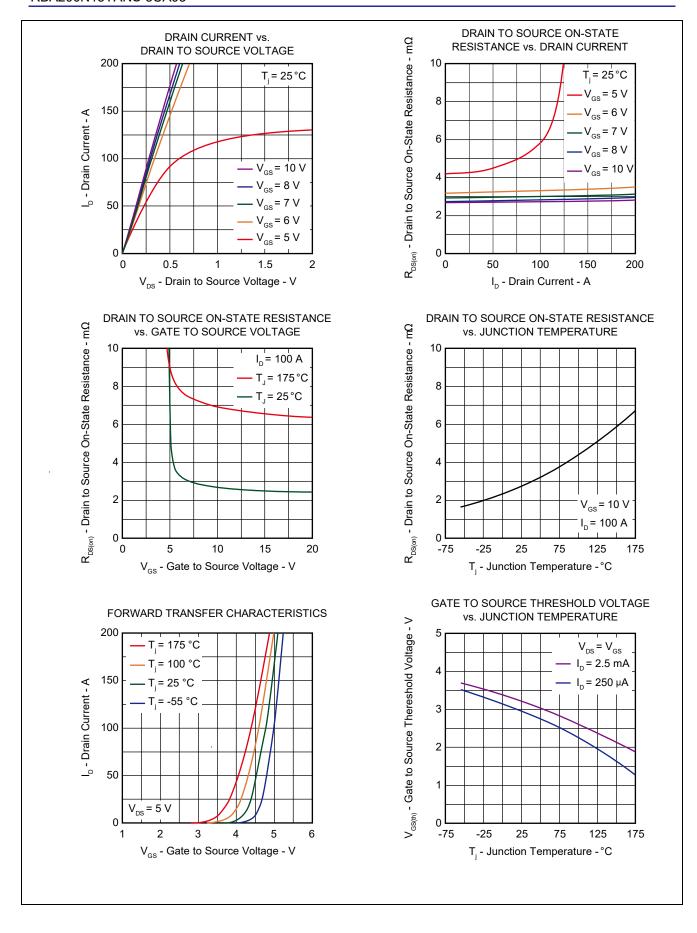
^{4.} L = 100 μ H, V_{DD} = 50 V, R_G = 25 Ω

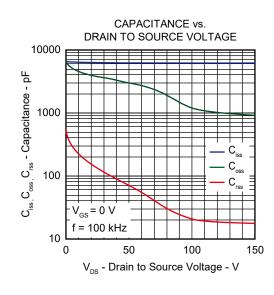
^{5.} Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4. (2 oz Cu pad.)

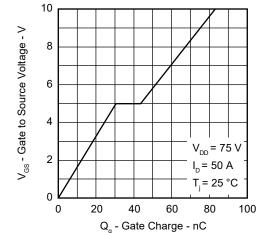
^{6.} Defined by design. Not subject to production test.

Typical Characteristics



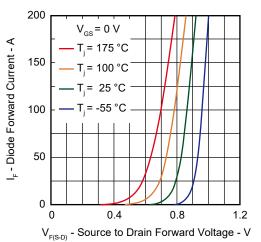


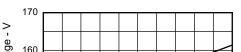




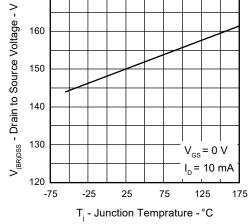
DYNAMIC INPUT/OUTPUT CHARACTERISTICS

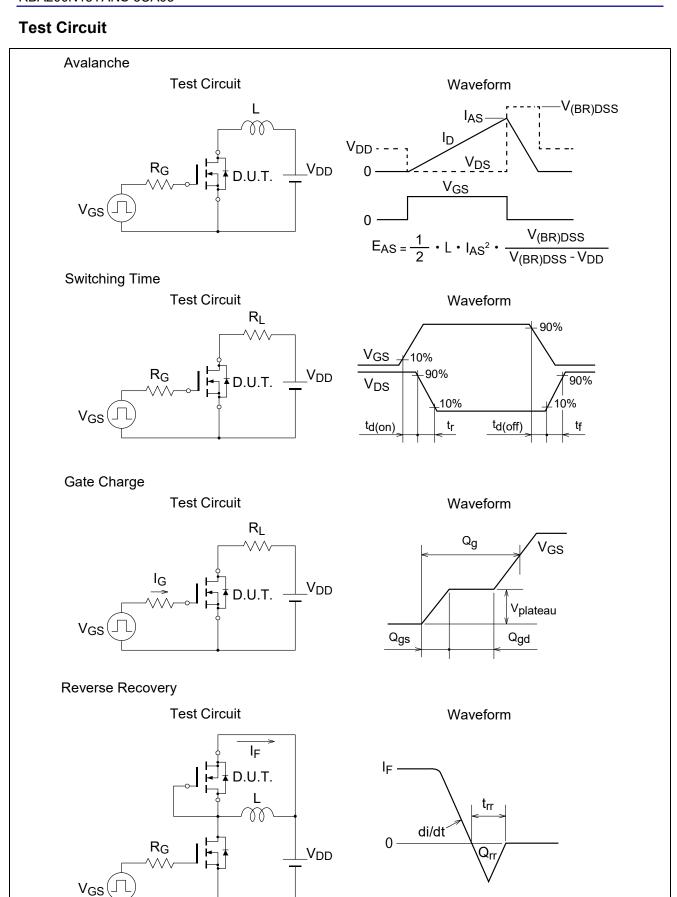




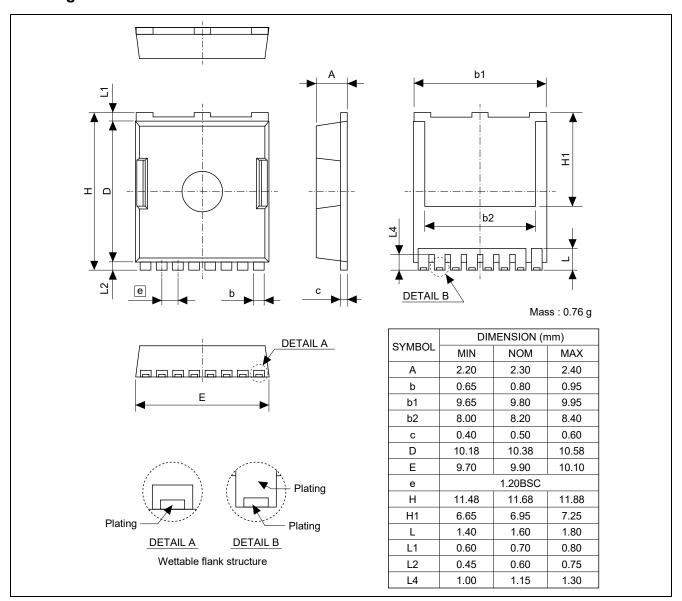


DRAIN-SOURCE BREAKDOWN BOLTAGE

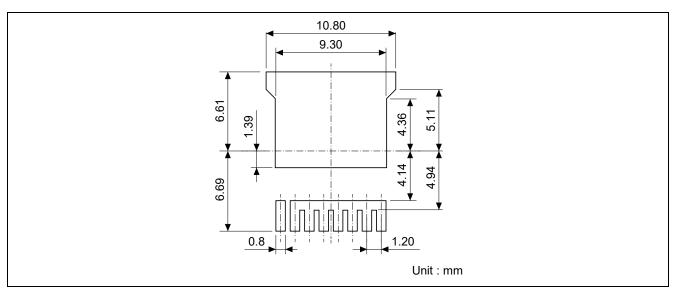




Package Dimensions



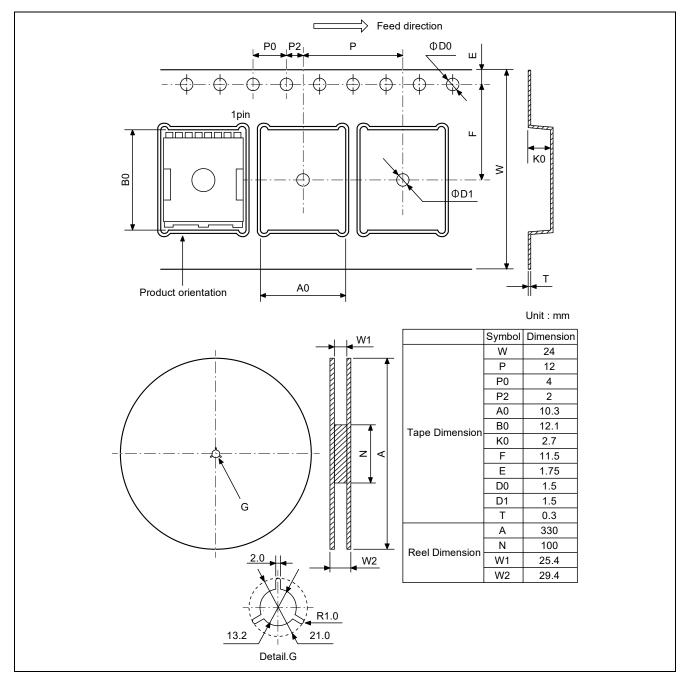
Mount pad



Ordering Information

Part No.	Packing	Quantity
RBA200N15YANS-3UA03#GB0	Taping	2000 pcs/reel

Packing Specification



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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